PSS Series SiPMs

Compared to conventional SiPM, NDL SiPM employs an intrinsic epitaxial layer as the quenching resistors and uses a continuous silicon capping layer as an anode to connect all APD cells. Thus, the device has a more compact structure and simpler fabrication technology, which allows for a larger micro-cell density (larger dynamic range) while adequate PDE. Furthermore, NDL SiPM helps implement a two-dimensional (2D) position-sensitive (PS) SiPM, which has attractive advantages of fewer output electrodes, simple readout electronics and a high position resolution.

Features

- ◆ Simple Readout Electronics
- ◆ High Position Resolution
- ◆ Large Dynamic Range While High PDE
- ◆ Fast Rise Time and Short Pulse Width
- ◆ Short Recovery Time and High Time Resolution
- ◆ Cost Effective

Applications

- ◆ High Energy Physics
- ◆ LiDAR
- ◆ Nuclear Medical Imaging (PET, SPECT, CT)
- ◆ Radiation Detection and Imaging
- ◆ Optical Spectroscope
- ◆ Other Low Level Light Position-Sensitive Detection

Specifications

Type	PSS 11-3030-S	PSS 11-6060-S
Effective Pitch	10 µm	20 µm
Active Area	3.0×3.0 mm^2	6.24×6.24 mm^2
Micro-cell Number	10000 /mm^2	2500 /mm^2
Typical Breakdown Voltage (V_B)	26.5 V	27.5 V
Peak PDE @420nm	32 %	40 %
Recommended Operation Voltage	$V_B + 5$ V	$V_B + 5$ V
Gain	2.0×10^5	8.0×10^5
Dark Count Rate (DCR)	650 kHz / mm^2	150 kHz / mm^2
Configuration of Anodes	Tetra-Lateral Anodes	Square-Bordered Anodes

Above parameters are measured at their recommended operation voltage and 20 ℃.
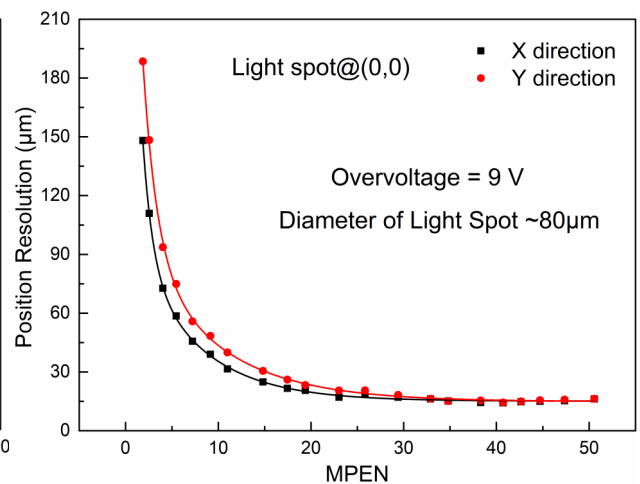
Characteristics of PSS 11-3030-S

Position Algorithm
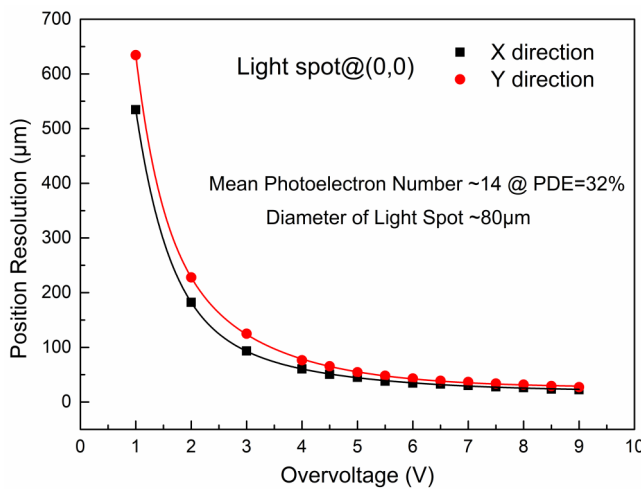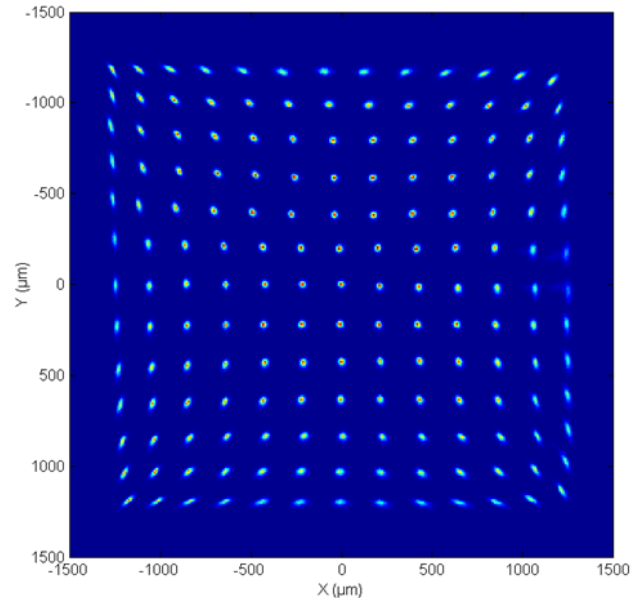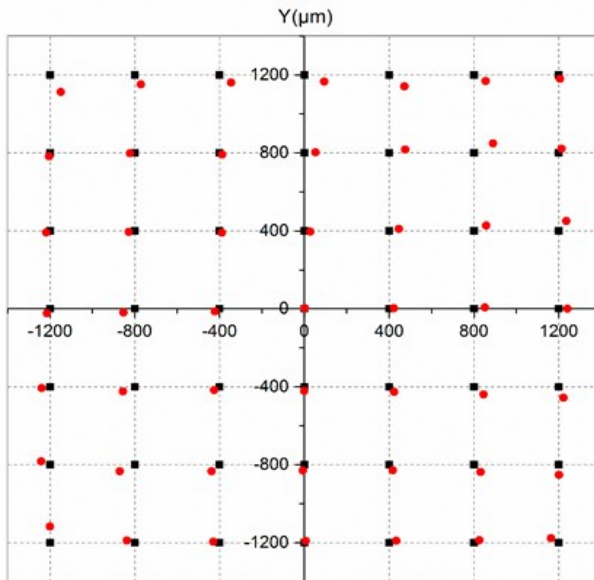
$$x_c = \frac{L}{2} \cdot \frac{\left(\frac{R_0}{R_s}+8.7492\right)(Q_4-Q_3)\left[\left(\frac{1.7R_0}{R_s}+5.8156\right)(Q_1+Q_2)+\left(\frac{R_0}{R_s}-5.8156\right)(Q_3+Q_4)\right]}{\left[\frac{R_0}{R_s}(Q_1+Q_2+Q_3+Q_4)\right]^2-\left[1.02\left(\frac{R_0}{R_s}+8.7492\right)(Q_2-Q_1)\right]^2}$$

$$y_c = \frac{L}{2} \cdot \frac{\left(\frac{R_0}{R_s}+8.7492\right)(Q_2-Q_1)\left[\left(\frac{R_0}{R_s}-5.8156\right)(Q_1+Q_2)+\left(\frac{1.7R_0}{R_s}+5.8156\right)(Q_3+Q_4)\right]}{\left[\frac{R_0}{R_s}(Q_1+Q_2+Q_3+Q_4)\right]^2-\left[1.02\left(\frac{R_0}{R_s}+8.7492\right)(Q_4-Q_3)\right]^2}$$

L is the length of the active area. R_0 is the sheet impedance, which is equal to 320 Ω. R_s is the load impedance. Q_i (i = 1, 2, 3, 4) is the shared charge of the corresponding anode.
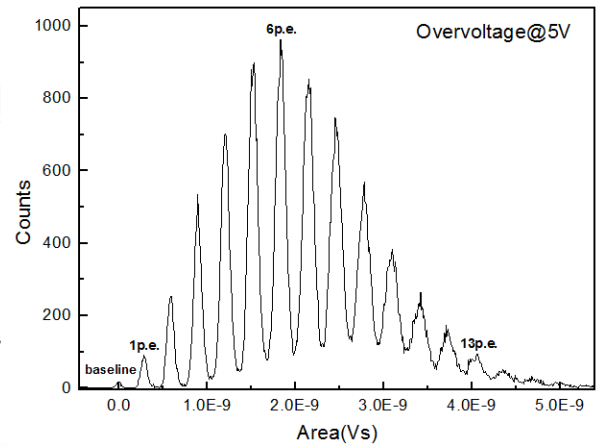
Test Conditions: OV=9 V if not specified, Temp.=20 °C, Load Impedance = 50 Ω.

Characteristics of PSS 11-6060-S

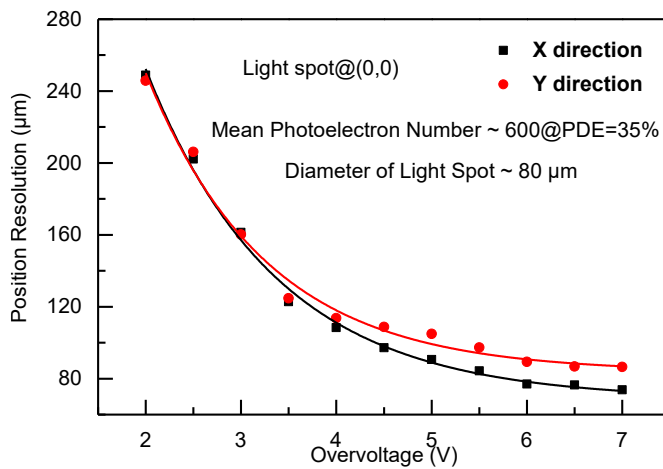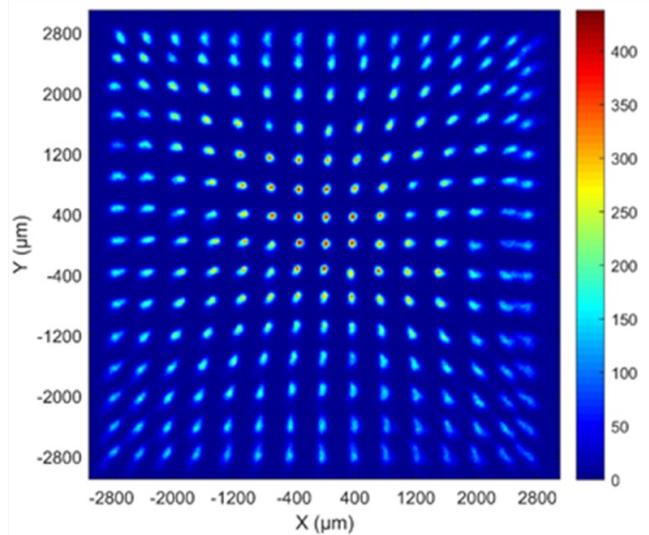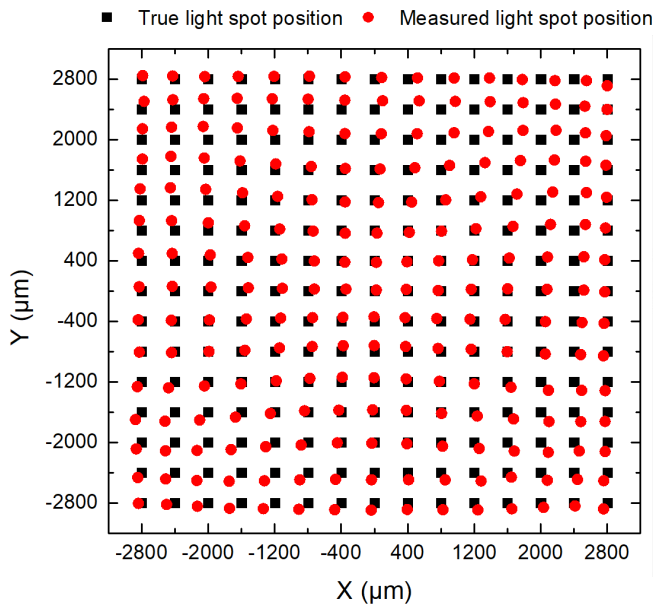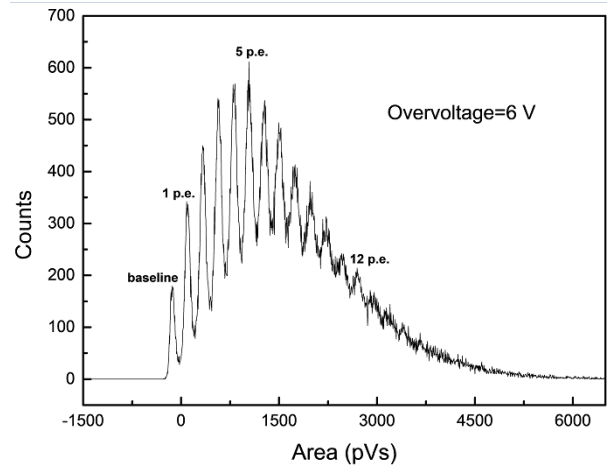### Position Algorithm

$$x_c = \frac{L}{2} \cdot k \cdot \frac{(Q_2 + Q_3) - (Q_1 + Q_4)}{(Q_1 + Q_2 + Q_3 + Q_4)}$$

$$y_c = \frac{L}{2} \cdot k \cdot \frac{(Q_3 + Q_4) - (Q_1 + Q_2)}{(Q_1 + Q_2 + Q_3 + Q_4)}$$
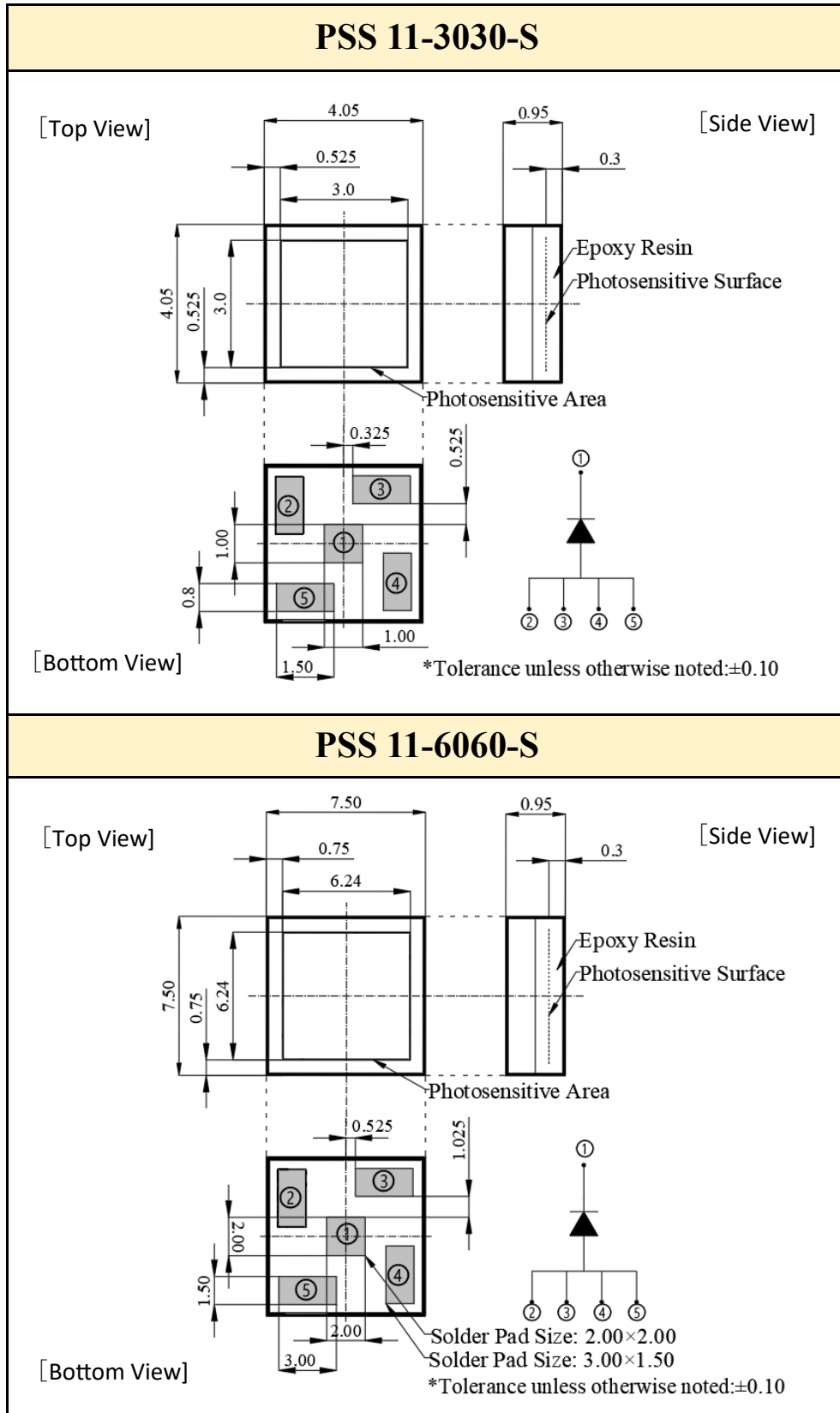
L is the length of the active area. Q_i (i = 1, 2, 3, 4) is the shared charge of the corresponding anode. k is the calibration factor.
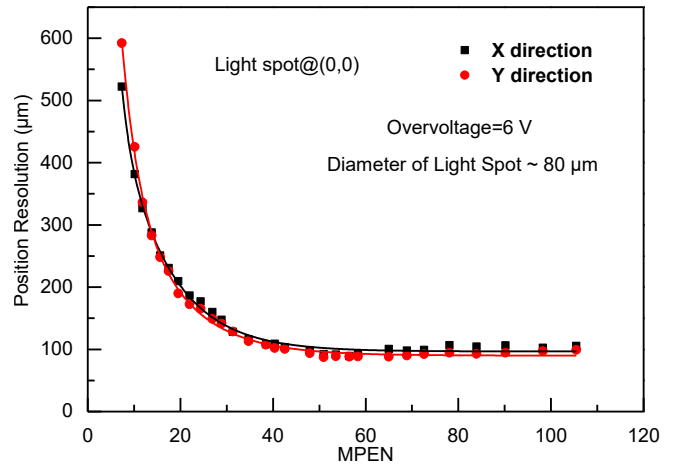
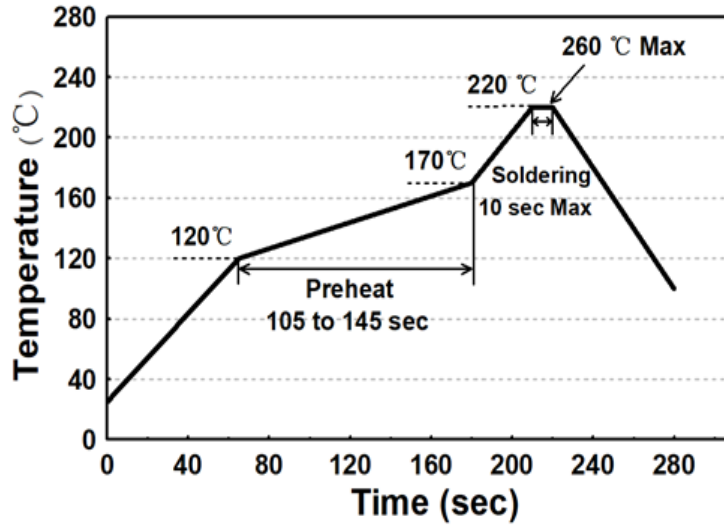**Test Conditions: OV=6 V if not specified, Temp.=20 °C.**

Dimensional outlines (unit: mm)

PSS 11-3030-S

[Top View]

[Side View]

4.05
0.525
3.0
4.05
0.525
3.0
0.95
0.3

Epoxy Resin
Photosensitive Surface
Photosensitive Area

0.325
0.525
1.00
0.8
②
③
①
④
⑤
1.00
1.50

①
② ③ ④ ⑤

[Bottom View]

*Tolerance unless otherwise noted:±0.10

PSS 11-6060-S

[Top View]

[Side View]

7.50
0.75
6.24
7.50
0.75
6.24
0.95
0.3

Epoxy Resin
Photosensitive Surface
Photosensitive Area

0.525
1.025
2.00
1.50
②
③
①
④
⑤
2.00
3.00

①
② ③ ④ ⑤

Solder Pad Size: 2.00×2.00
Solder Pad Size: 3.00×1.50
*Tolerance unless otherwise noted:±0.10

[Bottom View]

Recommended Solder Reflow Conditions

Basic Connection Diagrams

R1-4 = 1 kΩ
R5 = 50 Ω
C1-4 = 10 nF
C5 = 200 pF
C6 = 220 nF